



ALPHA & OMEGA
SEMICONDUCTOR

AO6408

20V N-Channel MOSFET

General Description

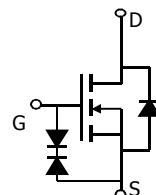
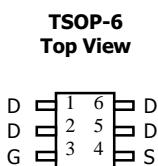
The AO6408 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. It offers operation over a wide gate drive range from 1.8V to 12V. It is ESD protected. This device is suitable for use as a load switch.

Features

$V_{DS} (V) = 20V$
 $I_D = 8.8A \quad (V_{GS} = 10V)$
 $R_{DS(ON)} < 18m\Omega \quad (V_{GS} = 10V)$
 $R_{DS(ON)} < 20m\Omega \quad (V_{GS} = 4.5V)$
 $R_{DS(ON)} < 25m\Omega \quad (V_{GS} = 2.5V)$
 $R_{DS(ON)} < 32m\Omega \quad (V_{GS} = 1.8V)$
 ESD Rating: 2000V HBM



ESD Protected
100% UIS Tested
100% Rg Tested



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ^A	I_D	8.8	A
$T_A=70^\circ C$		7	
Pulsed Drain Current ^B	I_{DM}	40	
Power Dissipation	P_D	2	W
$T_A=70^\circ C$		1.28	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	47.5	62.5	°C/W
Steady-State		74	110	°C/W
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	37	40	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =16V, V _{GS} =0V T _J =55°C			10 25	μA
I _{GSS}	Gate-Source leakage current	V _{DS} =0V, V _{GS} =±10V			±10	μA
BV _{GSO}	Gate-Source Breakdown Voltage	V _{DS} =0V, I _G =±250μA	±12			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.5	0.75	1	V
I _{D(ON)}	On state drain current	V _{GS} =4.5V, V _{DS} =5V	40			A
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =8.8A T _J =125°C		14.4 18.5	18	mΩ
		V _{GS} =4.5V, I _D =8A		16	20	mΩ
		V _{GS} =2.5V, I _D =6A		20.5	25	mΩ
		V _{GS} =1.8V, I _D =4A		25.6	32	mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =8.8A		33		S
V _{SD}	Diode Forward Voltage	I _S =1A		0.72	1	V
I _S	Maximum Body-Diode Continuous Current				3	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =10V, f=1MHz		1810	2200	pF
C _{oss}	Output Capacitance			232		pF
C _{rss}	Reverse Transfer Capacitance			200		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		1.6	2.2	Ω
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =10V, I _D =8.8A		17.9	22	nC
Q _{gs}	Gate Source Charge			1.5		nC
Q _{gd}	Gate Drain Charge			4.7		nC
t _{D(on)}	Turn-On Delay Time	V _{GS} =10V, V _{DS} =10V, R _L =1.1Ω, R _{GEN} =3Ω		3.3		ns
t _r	Turn-On Rise Time			5.9		ns
t _{D(off)}	Turn-Off Delay Time			44		ns
t _f	Turn-Off Fall Time			7.7		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =8.8A, dI/dt=100A/μs		22	27	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =8.8A, dI/dt=100A/μs		9.8		nC

A: The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

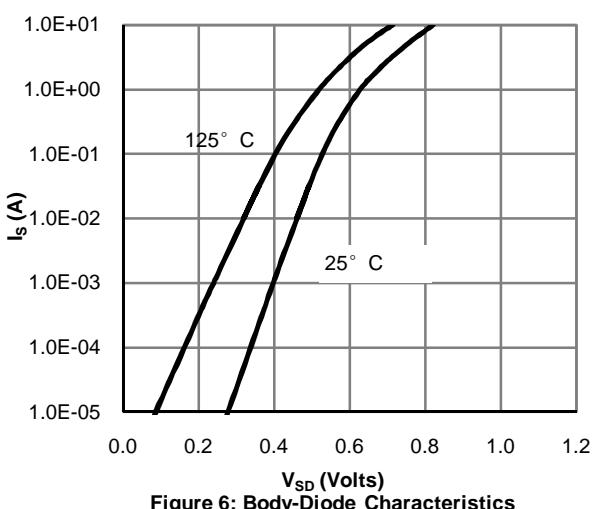
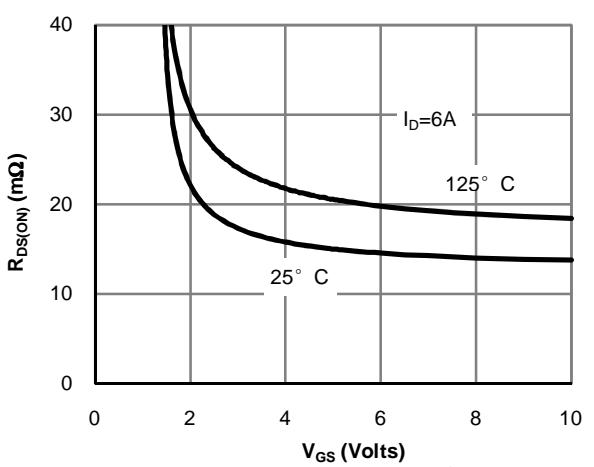
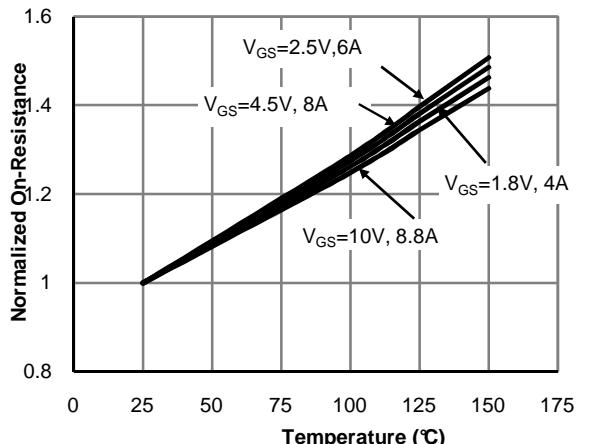
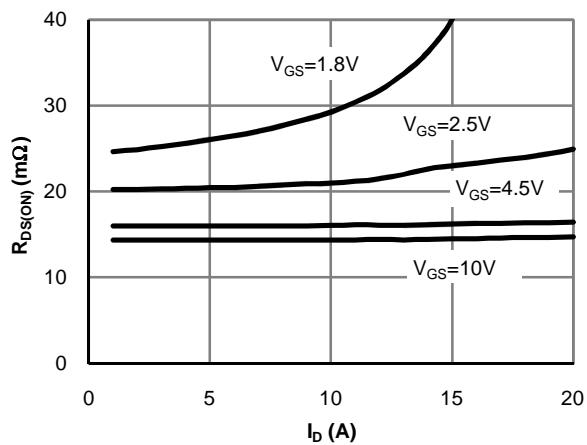
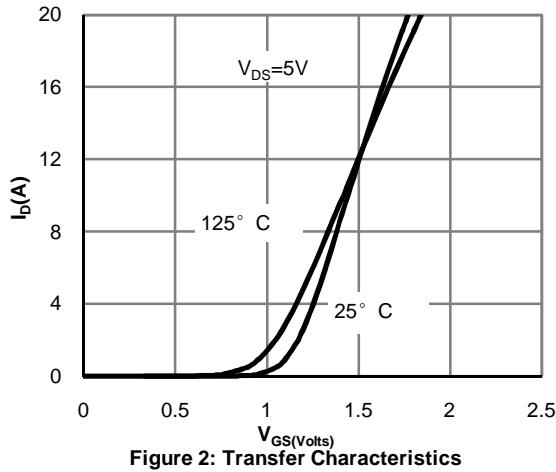
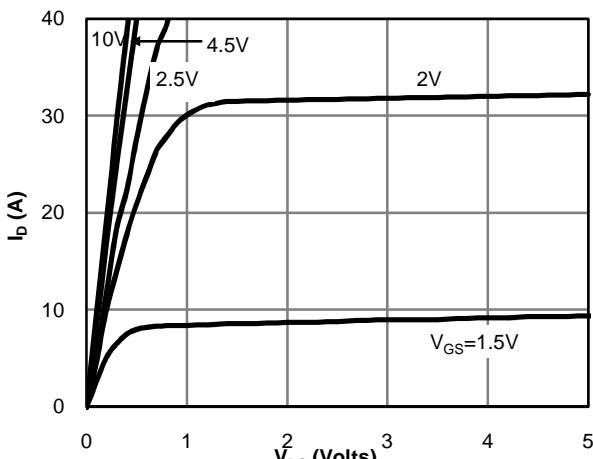
C. The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The SOA curve provides a single pulse rating. Rev3: August 2005

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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